MINI CROWN EDGE | CROWN EDGE

TE Internal #: 1766735-2

TE Internal Description: CONN,SKT W/LATCH,SMT,MC-P7S12

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Connector System: Board-to-Board

Number of Positions: 38

Centerline (Pitch): 1.27 mm [.05 in]

Contact Current Rating (Max): 25 A

Circuit Application: Power & Signal

Features

Product Type Features

| Connector Mates With | Printed Circuit Board |
|-----------------------------------|-----------------------|
| Connector & Housing Type | Receptacle |
| Connector & Contact Terminates To | Printed Circuit Board |
| Connector System | Board-to-Board |
| Configuration Features | |
| PCB Mount Orientation | Vertical |
| Number of Positions | 38 |
| Number of Power Positions | 14 |
| Number of Signal Positions | 24 |
| Number of Dual Positions | 7 |
| Electrical Characteristics | |
| Operating Voltage | 250 V |
| | |

Black

Contact Features

Primary Product Color

Body Features



| PCB Contact Termination Area Plating Material Thickness | 3.05 μm, 3.81 μm[120 μin][150 μin] |
|---|------------------------------------|
| Contact Layout | Inline |
| Contact Type | Socket |
| Contact Mating Area Plating Material Thickness | .76 μm[29.92 μin] |
| PCB Contact Termination Area Plating Material Finish | Matte |
| PCB Contact Termination Area Plating Material | Tin |
| Contact Base Material | Copper Alloy |
| Contact Current Rating (Max) | 25 A |
| Contact Mating Area Plating Material | Gold |
| Termination Features | |
| Termination Method to PCB | Surface Mount |
| Mechanical Attachment | |
| Mating Retention | With |
| Mating Alignment | With |
| PCB Mount Alignment | Without |
| PCB Mount Retention | With |
| PCB Mount Retention Type | Boardlock |
| Mating Retention Type | Latch |
| Connector Mounting Type | Board Mount |
| Housing Features | |
| Housing Material | Glass-Filled Polyester |
| Centerline (Pitch) | 1.27 mm[.05 in] |
| Dimensions | |
| Accepts Card Thickness | 1.57 mm[.062 in] |
| Card Slot Depth | 6 mm[.236 in] |
| Accepts Card Width | 93.37 mm[3.68 in] |
| Connector Height | 20 mm[.787 in] |
| Row-to-Row Spacing | 6.75 mm[.266 in] |
| Power Contact Centerline | 9.7 mm[.381 in] |
| Usage Conditions | |
| Operating Temperature Range | -55 – 105 °C[-67 – 221 °F] |
| Operation/Application | |



| Circuit Application | Power & Signal |
|---|----------------------|
| Industry Standards | |
| Compatible With Agency/Standards Products | CSA, UL |
| Compatible With Approved Standards Products | CSA 1935071, UL 1977 |
| UL Flammability Rating | UL 94V-0 |
| Packaging Features | |
| Packaging Quantity | 26 |
| Packaging Method | Box & Tray, Tray |

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC |
| Halogen Content | Not Low Halogen - contains Br or Cl > 900 ppm. |
| Solder Process Capability | Reflow solder capable to 260°C |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Also in the Series | CROWN EDGE





Card Edge Power Connectors(31)



Connector Contacts(1)



Customers Also Bought















Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1766735-2_F.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1766735-2_F.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1766735-2_F.3d_stp.zip

English

Datasheets & Catalog Pages

POWER_CONNECTORS_CATALOG_SEC04_VRM

English



Product Specifications
Application Specification

English